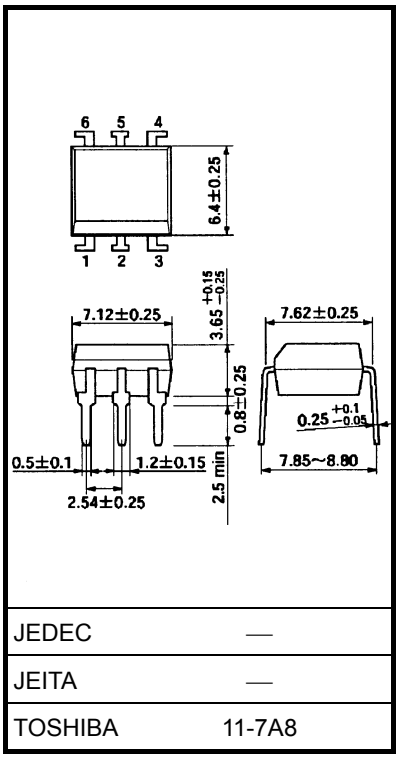
TOSHIBA Photocoupler IRED & Photo-Transistor

TLP572

Programmable Controllers
AC/DC-Input Module
Solid State Relay

Unit: mm



JEDEC	—
JEITA	—
TOSHIBA	11-7A8

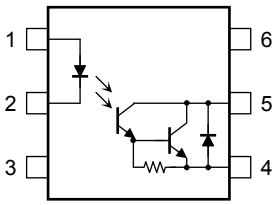
Weight: 0.4 g (typ.)

The TOSHIBA TLP572 consists of a darlington connected photo-transistor optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP package.

TLP572 is no-base internal connection for high-EMI environments.

- Collector-emitter voltage: 55 V (min)
- Current transfer ratio: 1000% (min)
- Isolation voltage: 2500 Vrms (min)
- UL recognized: UL1577, file No. E67349

Pin Configurations (top view)



1: Anode
2: Cathode
3: N.C.
4: Emitter
5: Collector
6: N.C.

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
LED	Forward current	I_F	50	mA
	Forward current derating (Ta ≥ 53°C)	I_F/°C	−0.7	mA/°C
	Peak forward current (100 μs pulse, 100 pps)	I_{FP}	1	A
	Reverse voltage	V_R	5	V
	Junction temperature	T_j	125	°C
Detector	Collector-emitter voltage	V_{CEO}	55	V
	Emitter-collector voltage	V_{ECO}	0.3	V
	Collector current	I_C	150/−10	mA
	Power dissipation	P_C	150	mW
	Power dissipation derating (Ta ≥ 25°C)	P_C/°C	−1.5	mW/°C
	Junction temperature	T_j	125	°C
Storage temperature range		T_{stg}	−55 to 125	°C
Operating temperature range		T_{opr}	−30 to 85	°C
Lead soldering temperature (10 s)		T_{sol}	260	°C
Total package power dissipation		P_T	200	mW
Total package power dissipation derating (Ta ≥ 25°C)		P_D/°C	−2.6	mW/°C
Isolation voltage (AC, 1 min., R.H. ≤ 60%) (Note)		BV_S	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: Device considered a two terminal device: Pins 1, 2 and 3 shorted together and pins 4, 5 and 6 shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Typ.	Max	Unit
Supply voltage	V_{CC}	—	12	24	V
Forward current	I_F	—	—	25	mA
Collector current	I_C	—	—	40	mA
Operating temperature	T_{opr}	−30	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	V_F	I_F = 10 mA	1.0	1.15	1.3	V
	Reverse current	I_R	V_R = 5 V	—	—	10	μA
	Capacitance	C_T	V = 0, f = 1 MHz	—	30	—	pF
Detector	Collector-emitter breakdown voltage	$V_{(BR)CEO}$	I_C = 1 mA	55	—	—	V
	Emitter-collector breakdown voltage	$V_{(BR)ECO}$	I_E = 0.1 mA	0.3	—	—	V
	Collector dark current	I_{CEO}	V_{CE} = 24 V	—	10	200	nA
			V_{CE} = 24 V, Ta = 85°C	—	0.5	10	μA
	Capacitance (collector to emitter)	C_{CE}	V = 0, f = 1 MHz	—	10	—	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Current transfer ratio	I_C/I_F	I_F = 1 mA, V_{CE} = 1.2 V	1000	2000	—	%
Collector-emitter saturation voltage	$V_{CE(sat)}$	I_C = 100 mA, I_F = 10 mA	0.3	—	1.2	V

Isolation Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Capacitance (input to output)	C_S	V_S = 0, f = 1 MHz	—	0.8	—	pF
Isolation resistance	R_S	V_S = 500 V, R.H. ≤ 60%	5×10^{10}	10^{14}	—	Ω
AC isolation voltage	BV_S	AC, 1 minute	2500	—	—	Vrms

Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Rise time	t_r	R_L = 100 Ω V_{CC} = 10 V, I_C = 10 mA	—	—	—	μs
Fall time	t_f		—	—	—	μs
Turn-on time	t_{on}		—	—	—	μs
Turn-off time	t_{off}		—	—	—	μs
Turn-on time	t_{ON}	R_L = 180 Ω (Figure 1) V_{CC} = 10 V, I_F = 10 mA	—	3	—	μs
Storage time	t_s		—	—	—	μs
Turn-off time	t_{OFF}		—	30	—	μs

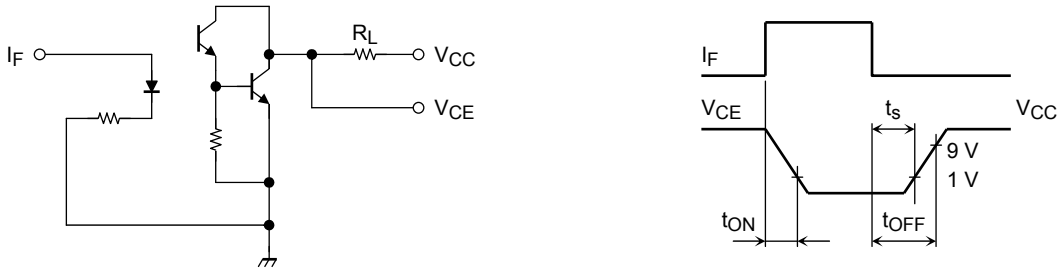
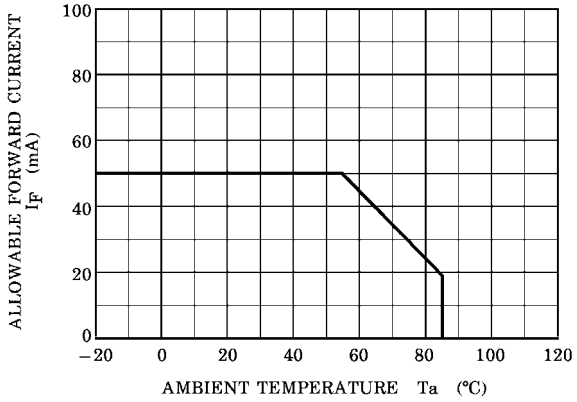
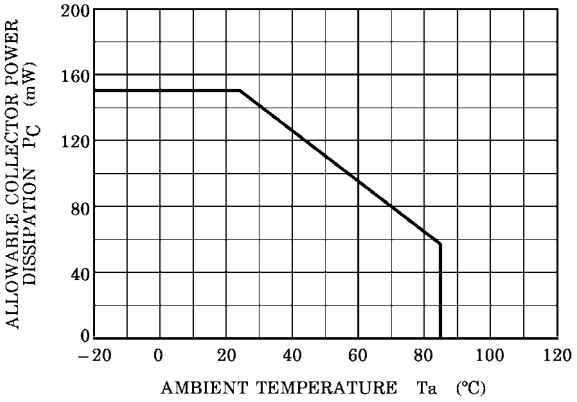


Figure 1 Switching Time Test Circuit

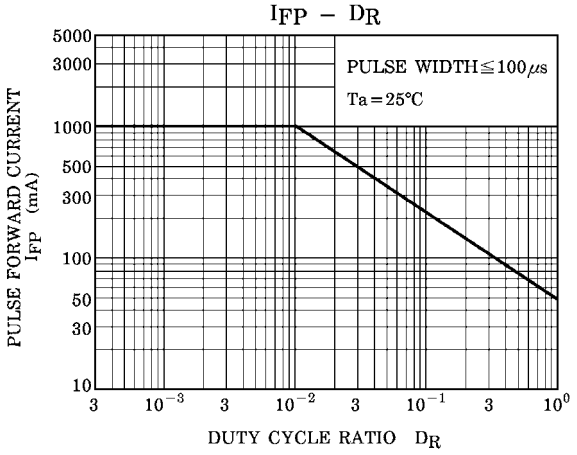
I_F – Ta



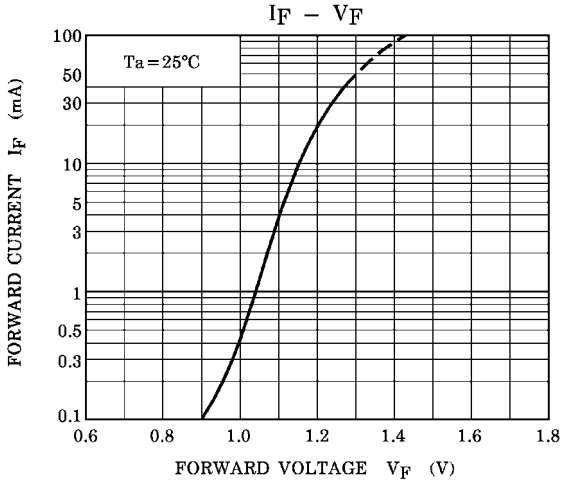
P_C – Ta



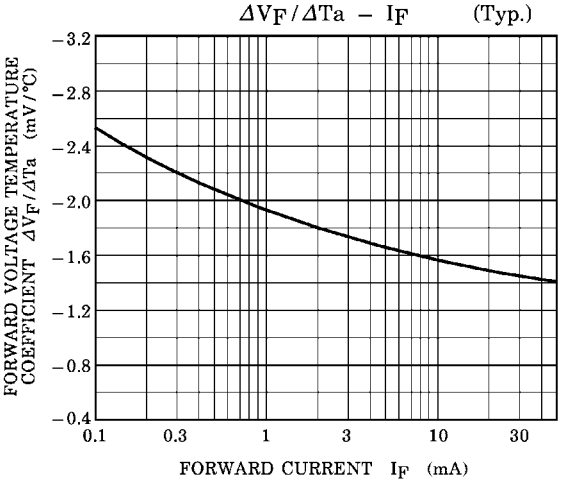
I_{FP} – D_R



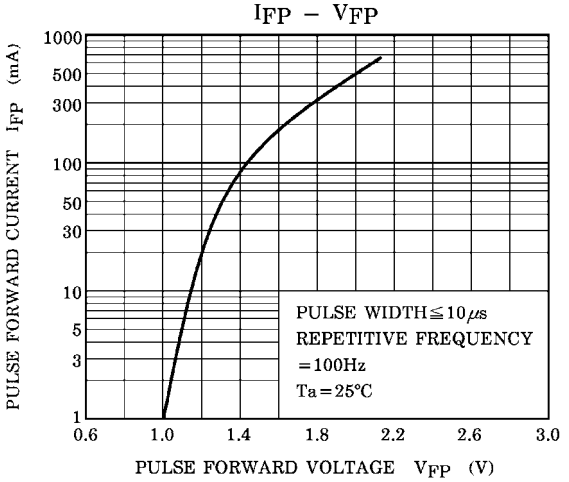
I_F – V_F



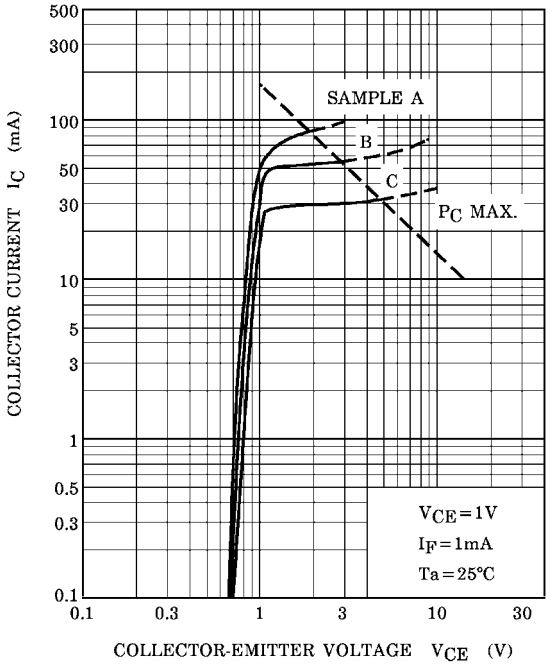
$\Delta V_F / \Delta Ta$ – I_F (Typ.)



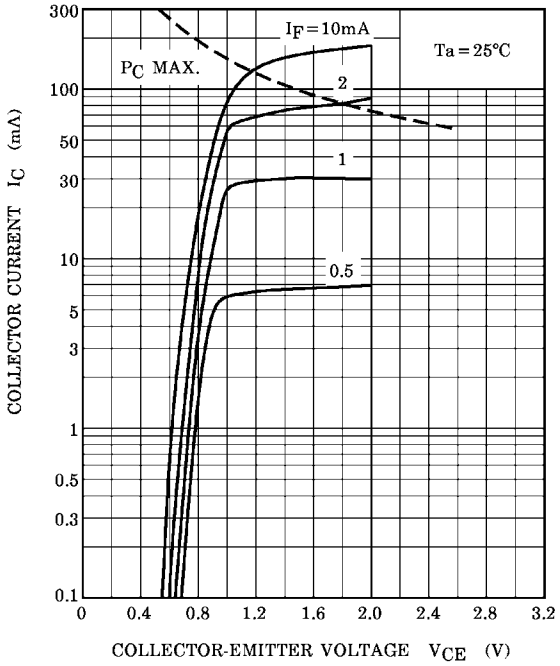
I_{FP} – V_{FP}



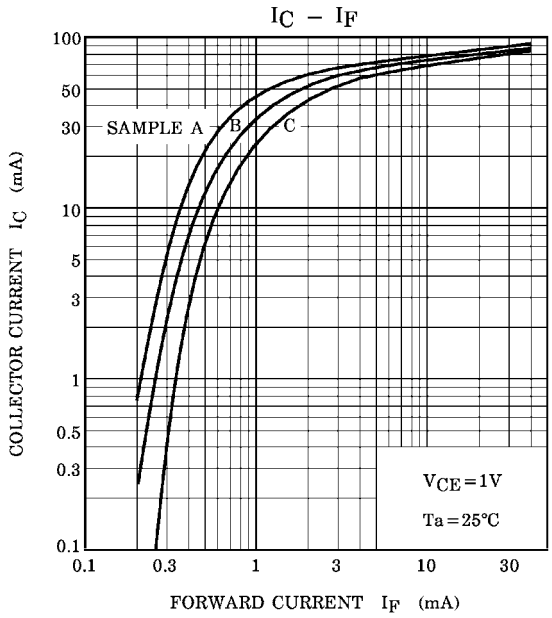
$I_C - V_{CE}$



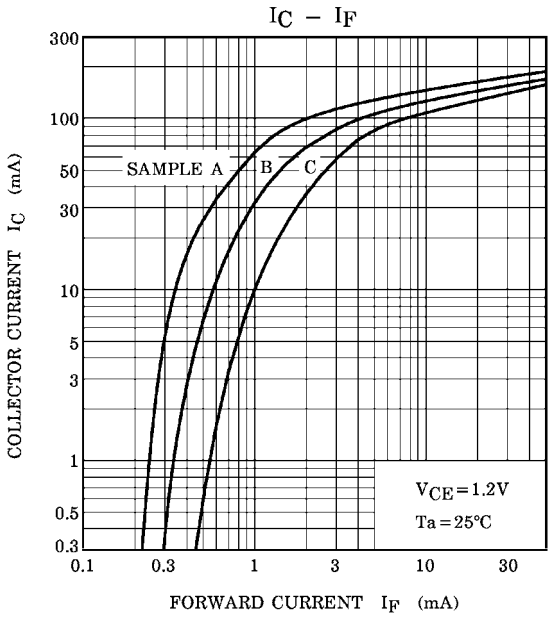
$I_C - V_{CE}$



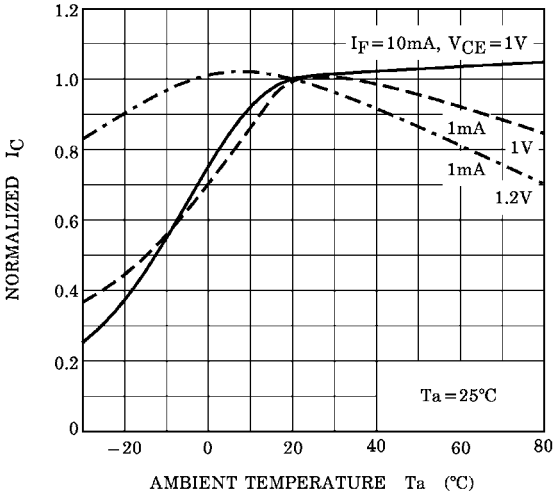
$I_C - I_F$



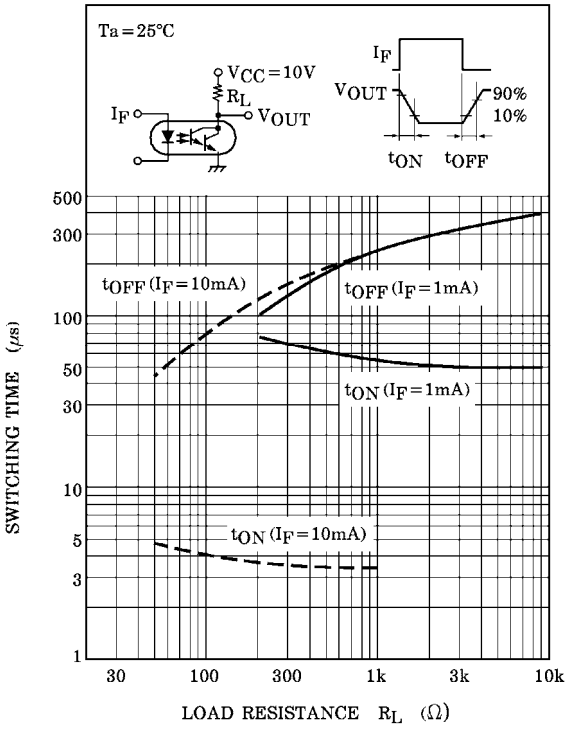
$I_C - I_F$



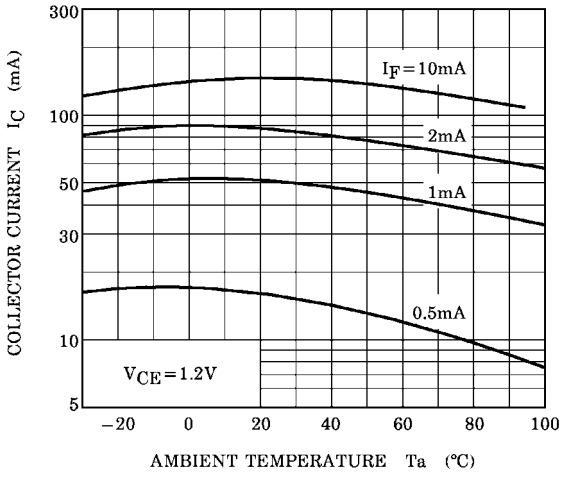
NORMALIZED I_C – Ta



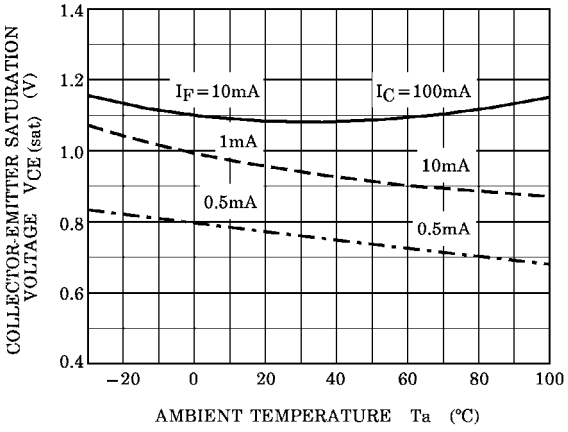
SWITCHING TIME



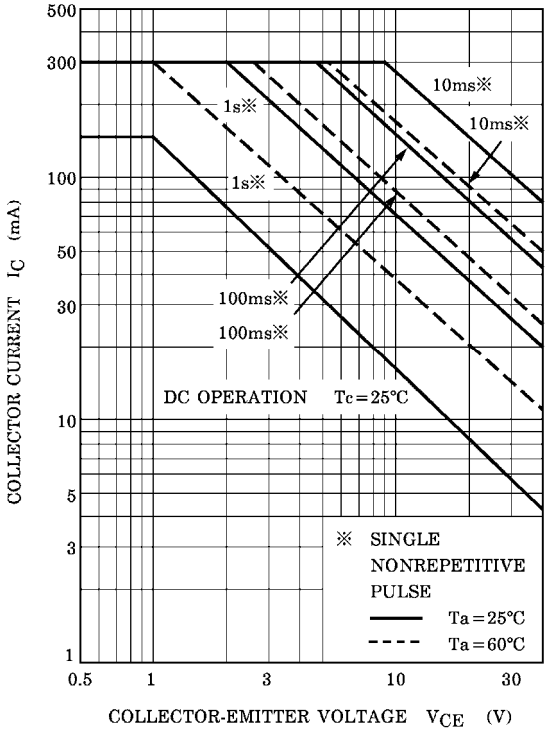
I_C – Ta



V_{CE} (sat) – Ta



SAFE OPERATING AREA



RESTRICTIONS ON PRODUCT USE

20070701-EN

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
  In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the “Handling Guide for Semiconductor Devices,” or “TOSHIBA Semiconductor Reliability Handbook” etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.).These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury (“Unintended Usage”). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in his document shall be made at the customer’s own risk.
- The products described in this document shall not be used or embedded to any downstream products of which manufacture, use and/or sale are prohibited under any applicable laws and regulations.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patents or other rights of TOSHIBA or the third parties.
- Product names mentioned herein may be trademarks of their respective companies.
- GaAs(Gallium Arsenide) is used in this product. The dust or vapor is harmful to the human body. Do not break, cut, crush or dissolve chemically.
- Please contact your sales representative for product-by-product details in this document regarding RoHS compatibility. Please use these products in this document in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances. Toshiba assumes no liability for damage or losses occurring as a result of noncompliance with applicable laws and regulations.